TIDA-01508 REV E1 Bill of Materials



TIDA-01508 REV E1 Bill of Materials										
Designator	Quantity	Value	PartNumber	Manufacturer	Description Description	PackageReference				
!PCB1 C1, C2, C3,	13	0.1uF	TIDA-01508 GRM188R71H104KA93D	Any MuRata	Printed Circuit Board CAP, CERM, 0.1 µF, 50 V,+/- 10%, X7R, 0603	0603				
C5_DI1, C5_DI2, C5_DI3, C5_DI4,										
C5_DI5, C5_DI4, C5_DI5, C5_DI6,										
C8_Ch7-8,										
C8_Ch9-10, C9_Ch7-8,										
C9_Ch9-10										
C4 C6_DI1, C6_DI2,	1 16	2200pF 0.01uF	202S41W222KV4E CGA2B3X7R1H103K050BB	Johanson Technology TDK	CAP, CERM, 2200 pF, 2000 V,+/- 10%, X7R, 1210 CAP, CERM, 0.01 μF, 50 V,+/- 10%, X7R, AEC-Q200 Grade 1, 0402	1210 0402				
C6_DI3, C6_DI4,		0.0.0	00/1220/11/11/100/100022		07.11 / 021.11.11, 010.1 pt. / 00 1/1/1 10/0/1/1/1/1/120 Q200 01.000 1/10 102	0.02				
C6_DI5, C6_DI6, C7_DI1, C7_DI2,										
C7_DI3, C7_DI4,										
C7_DI5, C7_DI6, C10_Ch7-8,										
C10_Ch9-10,										
C11_Ch7-8, C11_Ch9-10										
D1, D3	2	Red	150060RS75000	Wurth Elektronik	LED, Red, SMD	LED_0603				
D2, D4	2	36V	SM6T36CA	STMicroelectronics	Diode, TVS, Bi, 36 V, 64.3 Vc, SMB	SMB				
D5_DI1, D5_DI2, D5_DI6, D6_DI1,	8		CGA0603MLA-31900E	Bourns	ChipGuard Automotive MLA Series Varistor ESD Clamp Protectors	1.6x0.8mm				
D6_DI2, D6_DI3,										
D9_Ch7-8, D11_Ch9-10										
D7_DI1, D7_DI2,	16	Yellow	150060YS75000	Wurth Elektronik	LED, Yellow, SMD	LED_0603				
D7_DI3, D7_DI4, D7_DI5, D7_DI6,										
D8_DI1, D8_DI2,										
D8_DI3, D8_DI4,										
D8_DI5, D8_DI6, D10_Ch7-8,										
D10_Ch9-10,										
D12_Ch7-8, D12_Ch9-10										
FID1, FID2, FID3,	6		N/A	N/A	Fiducial mark. There is nothing to buy or mount.	N/A				
FID4, FID5, FID6										
J1, J2, J3, J4	4 2		SSW-110-23-F-S	Samtec	Connector, Receptacle, 100mil, 10x1, Gold plated, TH Header, 2.54mm, 10x1, Gold, TH	10x1 Receptacle				
J5, J8	2		61301011121	Wurth Elektronik	Header, 2.54mm, 10x1, Gold, 1H	Header, 2.54mm, 10x1, TH				
J6, J9	2		691356310010B	Wurth Elektronik	Header, 3.81mm, 5x2, R/A, Tin, TH	Header, 3.81mm, 5x2, TH				
J7, J10	2		0022284023	Molex	Header, 2.54mm, 2x1, Tin, TH	Header, 2.54mm, 2x1, TH				
K1, K2	2		CPC1117N	IXYS	Relay, SPST-NC (1 Form B), 0.15 A, SMD	4.089x3.81mm				
LBL1	1		THT-14-423-10	Brady	Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll	PCB Label 0.650 x 0.200 inch				
R1, R5, R7, R8	4	100	CRCW0603100RFKEA	Vishay-Dale	RES, 100, 1%, 0.1 W, 0603	0603				
R2, R3 R4, R6	2	47 0	CRCW060347R0JNEA CRCW06030000Z0EA	Vishay-Dale Vishay-Dale	RES, 47, 5%, 0.1 W, 0603 RES, 0, 5%, 0.1 W, 0603	0603 0603				
R10_DI1,		562	CRCW0402562RFKED	Vishay-Dale	RES, 562, 1%, 0.063 W, 0402	0402				
R10_DI2, R10_DI3,										
R10_DI3, R10_DI4,										
R10_DI5,										
R10_DI6, R12_DI1,										
R12_DI2,										
R12_DI3, R12_DI4,										
R12_DI5,										
R12_DI6, R16_Ch7-8,										
R16_Ch9-10,										
R19_Ch7-8, R19_Ch9-10										
R13_DI1,	16	750	CRCW0603750RFKEA	Vishay-Dale	RES, 750, 1%, 0.1 W, 0603	0603				
R13_DI2, R13_DI3,										
R13_DI4,										
R13_DI5, R13_DI6,										
R14_DI1,										
R14_DI2,										
R14_DI3, R14_DI4,										
R14_DI5,										
R14_DI6, R17_Ch7-8,										
R17_Ch9-10,										
R20_Ch7-8, R20_Ch9-10										
1.20_0113-10			1							

Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
SH-J1, SH-J2	2	7 41.41	60900213421	Wurth Elektronik	Shunt, 2.54mm, Gold, Black	Shunt, 2.54mm, Black
114 119	2		SN74LV165AD	Texas Instruments	Parallel-Load 8-Bit Shift Registers, D0016A, TUBE	D0016A
U1, U2 U3	1					DBV0005A
			SN74LVC1GU04DBVR	Texas Instruments	Single Inverter Gate, DBV0005A, LARGE T&R	
U4_DI3, U4_DI4,	16		TVS3300YZFR	Texas Instruments	33V Precision Surge Protection Clamp, YZF0004-C01 (DSBGA-4)	YZF0004-C01
U4_DI5, U6_DI3,						
U6_DI4, U6_DI5,						
U7_DI4, U7_DI5,						
U7_DI6, U8_DI4,						
U8_DI5, U8_DI6,						
U10_Ch9-10,						
U11_Ch9-10,						
U13_Ch7-8,						
U14_Ch7-8						
U5_DI1, U5_DI2,	6		ISO1212DBQR	Texas Instruments	ISO1212DBQR, DBQ00016A, DBQ0016A (SSOP-16)	DBQ0016A
U5_DI3, U5_DI4,						
U5_DI5, U5_DI6						
U9_Ch7-8,	4		ISO1211DR	Texas Instruments	ISO1211DR, D0008B (SOIC-8)	D0008B
U9_Ch9-10,						
U12_Ch7-8,						
U12_Ch9-10						
D5_DI3, D5_DI4,	0		CGA0603MLA-31900E	Bourns	ChipGuard Automotive MLA Series Varistor ESD Clamp Protectors	1.6x0.8mm
D5_DI5, D6_DI4,						
D6_DI5, D6_DI6,						
D9_Ch9-10,						
D11_Ch7-8						
U4_DI1, U4_DI2,	0		TVS3300YZFR	Texas Instruments	33V Precision Surge Protection Clamp, YZF0004-C01 (DSBGA-4)	YZF0004-C01
U4_DI6, U6_DI1,						
U6_DI2, U6_DI6,						
U7_DI1, U7_DI2,						
U7_DI3, U8_DI1,						
U8_DI2, U8_DI3,						
U10 Ch7-8,						
U11 Ch7-8,						
U13 Ch9-10,						
U14 Ch9-10						

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